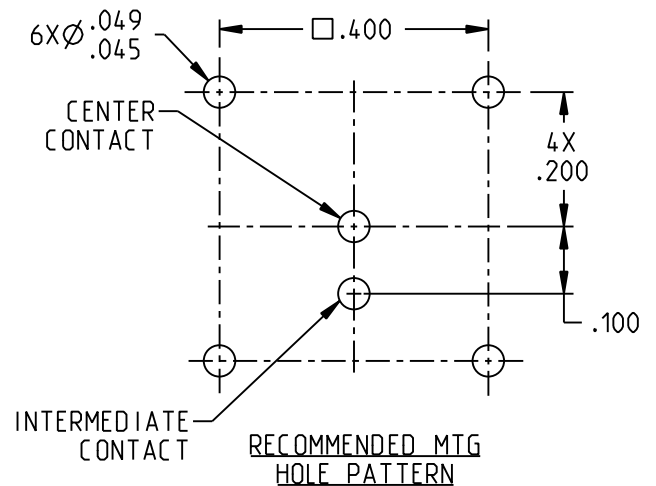
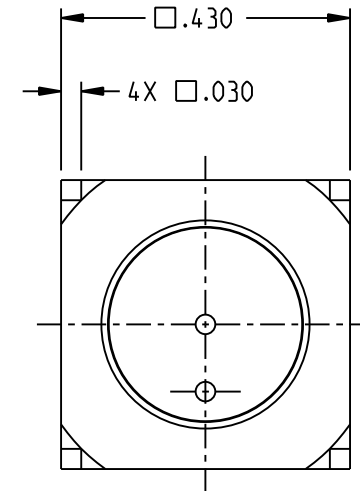
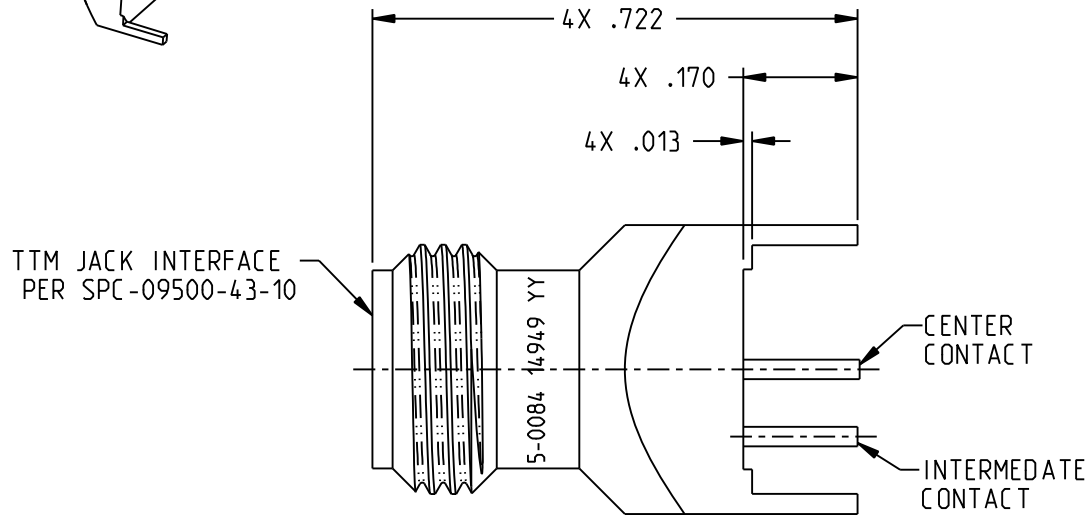
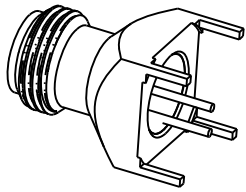




NOTES: UNLESS OTHERWISE SPECIFIED.

1. MATERIAL & FINISH:

- 1.1 BODY: GOLD PLATED BRASS
- 1.2 INSULATOR & DIELECTRIC: PTFE (TEFLON)
- 1.3 INTERMEDIATE CONTACT: GOLD PLATED BRASS
- 1.4 CENTER CONTACT: GOLD PLATED BERYLLIUM COPPER

2. ELECTRICAL:

- 2.1 IMPEDANCE: NON-CONSTANT
- 2.2 FREQUENCY: 500 MHz MAX.

3. MAXIMUM BOARD THICKNESS: .125

4. TESTED TO TT-09 I.A.W TCS-150.

5. WORKMANSHIP PER TFS-10.

	3RD ANGLE PROJECTION 	TROMPETER	
NOTICE: The information in this drawing is PROPRIETARY and must not be used without the permission of Cinch Connectivity Solutions. It may contain data whose export is restricted. Verify status prior to exporting. INTERPRET DRAWING IN ACCORDANCE WITH ASME Y14.5-2018		Title: TTM JACK, CIRCUIT BOARD MOUNT	Model No. 5-0084 Size A DO NOT SCALE DRAWING Date: 10/7/2021 Sheet 1 OF 1
UNLESS OTHERWISE SPECIFIED UNITS: INCH RoHS2 2015/863/EU .XX ±.02 .XXX ±.005 ANGLES ±2°			